

# **High Efficiency PWM Buck LED Driver Controller**

## **General Description**

The RT8458A is a PWM controller with an integrated high side gate driver. It is used for step down converters by well controlling the external MOSFET and regulating a constant output current. The output duty cycle of the RT8458A can be up to 100% for wider input voltage application, such as E27 and PAR30 off-line LED lighting products.

The RT8458A also features a 47kHz fixed frequency oscillator, an internal -220mV precision reference, and a PWM comparator with latching logic. The accurate output LED current is achieved by an averaging current feedback loop and the LED current dimming can be easily controlled via the ACTL pin. The RT8458A also has multiple features to protect the controller from fault conditions, including Under Voltage Lockout (UVLO), Over Current Protection (OCP) and Over Voltage Protection (OVP). Additionally, to ensure the system reliability, the RT8458A is built with the thermal protection function.

The RT8458A is housed in a TSOT-23-6 package. Thus, the components in the whole LED driver system can be made very compact.

#### **Features**

- Low Cost and Efficient Buck Converter Solution
- Universal Input Voltage Range with Off-Line **Topology**
- Programmable Constant LED Current
- Dimmable LED Current by ACTL
- Output LED String Open Protection
- Output LED String Short Protection
- Output LED String Over Current Protection
- Built-in Thermal Protection
- TSOT-23-6 Package
- RoHS Compliant and Halogen Free

## **Applications**

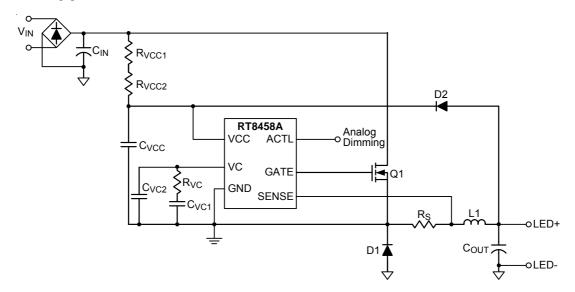
• E27, PAR30, Offline LED Lights

## **Marking Information**

07=DNN

07= : Product Code DNN: Date Code

# **Simplified Application Circuit**





## **Ordering Information**

RT8458A -Package Type J6: TSOT-23-6

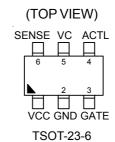
> Lead Plating System G: Green (Halogen Free and Pb Free)

Note:

Richtek products are:

- RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

# **Pin Configurations**

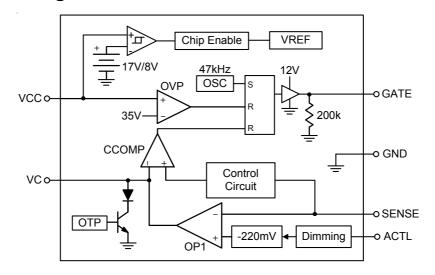


## **Functional Pin Description**

Pin No.	Pin Name	Pin Function
1	VCC	Supply Voltage Input of the Chip. For good bypass, a ceramic capacitor near the VCC pin is required.
2	GND	Ground of the Chip.
3	GATE	Gate Driver Output for External MOSFET Switch.
4	ACTL	Analog Dimming Control Input. The effective dimming range is between 0.1V to 1.2V. If V <sub>ACTL</sub> is greater than 1.2V, the ACTL dimming signal high is internally clamped around 1.3V. If dimming is not used, a pull up resistor or a voltage holding capacitor between ACTL and GND pins should be used.
5	VC	PWM Loop Compensation Node.
6	SENSE	LED Current Sense Input. The Typical sensing threshold is -220mV between the SENSE and GND pin.



### **Function Block Diagram**



### **Operation**

The RT8458A is a Buck PWM current mode controller with an integrated high side gate driver. The start up voltage of RT8458A is around 17V. Once VCC is above 17V, RT8458A will maintain operation until VCC drops below 8V.

The RT8458A's main control loop consists of a 47kHz fixed frequency oscillator, an internal –220mV precision current sense threshold OPAMP (OP1), and a PWM comparator (CCOMP) with latching logic. In normal operation, the GATE turns high when the gate driver is set by the oscillator (OSC). The lower the average of the sensed current is below the loop-regulated –220mV threshold, the higher the VC pin voltage (OP1 output) will go high. Higher the VC voltage means longer the GATE turn-on period. The GATE of RT8458A can turn on more than 100% duty. It is not always that the GATE turns low

in each OSC cycle. The GATE turns low until the current comparator (CCOMP) resets the gate driver. The GATE will be set high again by OSC and the next switching cycle repeats.

The adjustment of the regulated sense current threshold (dimming) can be achieved by varying ACTL pin voltage. The typical range of ACTL voltage adjustment is between 0.1V and 1.2V.

The RT8458A is equipped with protection from several fault conditions, including input voltage Under Voltage Lockout (UVLO), Over Current Protection (OCP) and VIN/VOUT Over Voltage Protection (OVP). Additionally, to ensure the system reliability, the RT8458A is built with internal thermal protection function.



# Absolute Maximum Ratings (Note 1)

• Supply Input Voltage, VCC	0.3V to 40V
• GATE Voltage (Note 8)	0.3V to 17V
• ACTL Voltage (Note 6)	0.3V to 8V
• VC Voltage	0.3V to 6V
• SENSE Voltage	1V to 0.3V
<ul> <li>Power Dissipation, P<sub>D</sub> @ T<sub>A</sub> = 25°C</li> </ul>	
TSOT-23-6	- 0.392W
Package Thermal Resistance (Note 2)	
TSOT-23-6, θ <sub>JA</sub>	- 255°C/W
TSOT-23-6, θ <sub>JC</sub>	- 135°C/W
• Junction Temperature	- 150°C
• Lead Temperature (Soldering, 10 sec.)	- 260°C
• Storage Temperature Range	65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	- 2kV
MM (Machine Model)	- 200V
Recommended Operating Conditions (Note 4)	
• Supply Input Voltage, VCC	- 17V to 31V

• Junction Temperature Range ----- --- -40°C to 125°C

## **Electrical Characteristics**

( $V_{CC}$  = 24 $V_{DC}$ ,  $T_A$  = 25°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Input Start-Up Voltage	VsT			17	19	٧	
Minimum Operation Voltage After Start-Up	VIN(MIN)			8	9	٧	
Maximum Startup Current in VCC Hiccup Operation	I <sub>ST(MAX)</sub>	Maximum I <sub>CC</sub> to cause V <sub>CC</sub> stop hiccup at low end of V <sub>CC</sub> hysteresis level	-	250	300	μΑ	
Input Supply Current	Icc	After Start-Up, V <sub>CC</sub> = 24V		2	5	mA	
Input Shutdown Current	IQC	Before Start-Up, V <sub>CC</sub> = 5V		1	5	μΑ	
Oscillator							
Switching Frequency	fsw		38	47	56	kHz	
Maximum Duty in Transient Operation	D <sub>MAX(TR)</sub>	V <sub>C</sub> = 3V		1	100	%	
Maximum Duty in Steady State Operation	D <sub>MAX</sub>			97	1	%	
Blanking Time	tBLANK	(Note 7)		300		ns	
Minimum Off Time	toff(MIN)	(Note 7)		600	-	ns	



Parameter	rameter Symbol Test Conditions		Min	Тур	Max	Unit	
Current Sense Amplifier							
Current Sense Voltage	VSENSE	(Note 5)	-213	-220	-227	mV	
Sense Input Current	ISENSE	(Note 7)		11		μΑ	
VC Sourcing Current	I <sub>VC_Source</sub>	V <sub>SENSE</sub> = -150mV (Note 7)		20		μΑ	
VC Sinking Current	I <sub>VC_Sink</sub>	V <sub>SENSE</sub> = -250mV (Note 7)		180		μΑ	
VC Threshold for PWM Switch Off	V <sub>VC</sub>		1.15	1.25	1.35	V	
GATE Driver Output							
GATE Pin Maximum Voltage	VGATE	No Load at GATE Pin		12.6	16	V	
CATE Voltage Lligh	.,	I <sub>GATE</sub> = -50mA	10.5	12.1	14	V	
GATE Voltage High	VGATE_H	I <sub>GATE</sub> = -100μA		12.5		V	
CATE Voltage Levy	V	I <sub>GATE</sub> = 50mA	0.01	0.75	1.2	V	
GATE Voltage Low	V <sub>GATE_L</sub>	I <sub>GATE</sub> = 100μA		0.5			
GATE Drive Rise Time		1nF Load at GATE		60	150	ns	
GATE Driver Fall Time		1nF Load at GATE		30	100	ns	
GATE Drive Source Peak Current		1nF Load at GATE		0.25	0.5	Α	
GATE Driver Sink Peak Current		1nF Load at GATE		0.5	0.8	Α	
LED Dimming			•	•			
Analog Dimming ACTL Pin Input Current	IACTL	V <sub>ACTL</sub> = 1.2V		1	5	μА	
LED Current On Threshold at ACTL	V <sub>ACTL_On</sub>			1.2	1.3	V	
LED Current Off Threshold at ACTL	V <sub>ACTL_Off</sub>			0.1	0.2	V	
OVP							
Over Voltage Protection Vov		VCC Pin	32	35	38	V	
Thermal Protection							
Thermal Shutdown Temperature	T <sub>SD</sub>			150		°C	

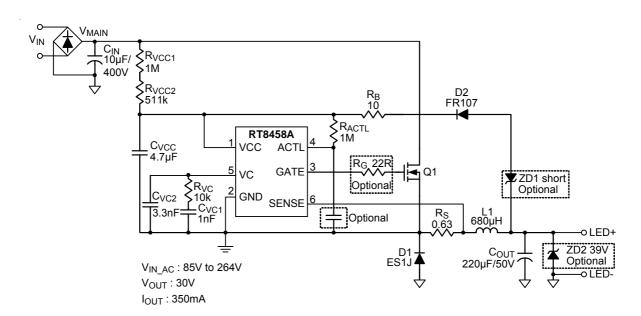
- **Note 1.** Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2.  $\theta_{JA}$  is measured at  $T_A = 25^{\circ}C$  on a low effective thermal conductivity single-layer test board per JEDEC 51-3.  $\theta_{JC}$  is measured at the exposed pad of the package.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.
- **Note 5.** The RT8458A achieves precise LED average current with a current feedback loop to sense the average LED current, in the deep discontinuous mode operation especially when a small inductor is used small current offset might occur due to current waveform distortion of the nature of the discontinuous operation. This offset current is consistent over production.
- **Note 6.** If a  $1M\Omega$  resistor is connected between the control input and ACTL pin, the control input voltage can be up to 36V.
- Note 7. Guaranteed by design, not subjected to production test.
- Note 8. The GATE voltage is internally clamped and varies with operating conditions.

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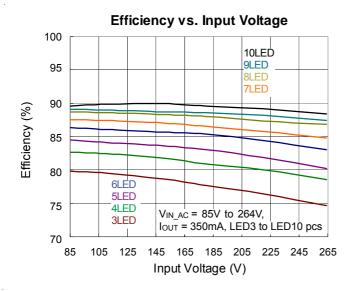
# **Typical Application Circuit**

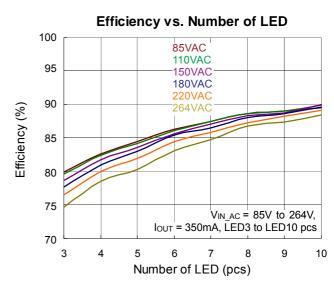


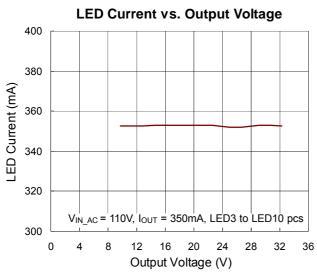
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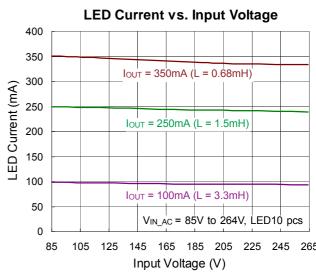


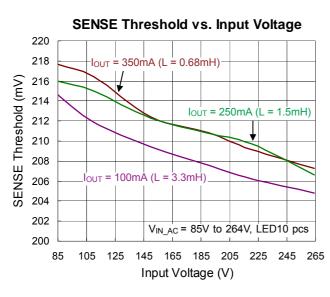
## **Typical Operating Characteristics**

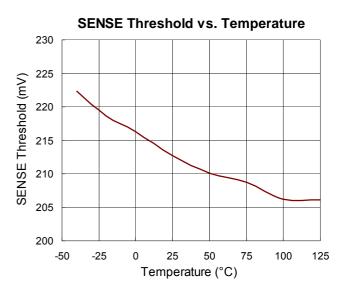










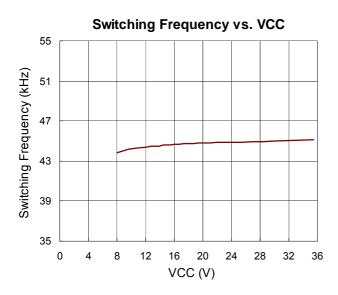


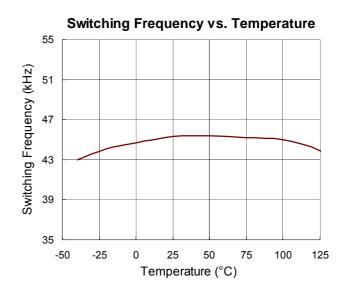
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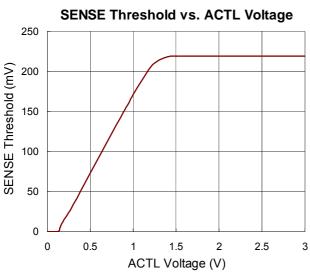
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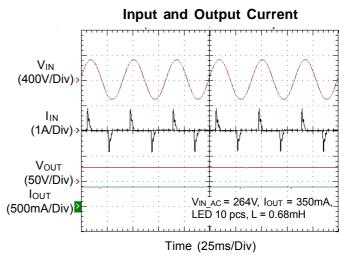
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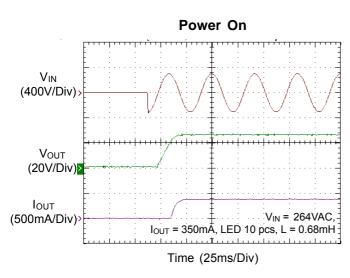


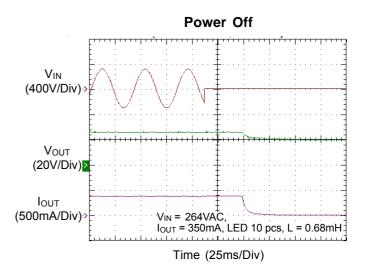














## **Application Information**

The RT8458A is a high efficiency PWM Buck LED driver controller for high brightness LED application. Its high side floating gate driver is used to control the Buck converter via an external MOSFET and regulate the constant output current.

The RT8458A can achieve high accuracy LED output current via the average current feedback loop control. The internal sense voltage (-220mV typ.) is used to set the average output current. The oscillator's frequency is fixed at 47kHz to get better switching performance. Once the average current is set by the external resistor,  $R_S$ , the output LED current can be dimmed by varying the ACTL voltage.

#### **Under Voltage Lockout (UVLO)**

The RT8458A includes a UVLO feature with 9V hysteresis. The GATE terminal turns on when  $V_{\text{IN}}$  rises over 17V (typ.). The GATE terminal turns off when  $V_{\text{IN}}$  falls below 8V (typ.)

#### **Setting Average Output Current**

The output current that flows through the LED string is set by an external resistor,  $R_{\rm S}$ , which is connected between the GND and SENSE pins. With ACTL pin voltage greater than 1.2V, the relationship between output current,  $I_{\rm OUT}$ , and  $R_{\rm S}$  is shown below :

$$I_{OUT} = \frac{0.22}{R_S} \quad (A)$$

#### **Analog Dimming Control**

The ACTL terminal is driven by an external voltage,  $V_{ACTL}$ , to adjust the output current to an average value set by  $R_S$ . The voltage range for  $V_{ACTL}$  to adjust the output current is from 0.1V to 1.2V. For  $V_{ACTL}$  between 0.1V to 1.2V, the output current value will be determined by the following formula:

$$I_{OUTavg} = (0.22V/R_S) \times \frac{V_{ACTL} - 0.1}{1.1}$$

#### **Component Selection**

For component selection, an example is shown below for a typical RT8458A application, where  $V_{\text{IN}}$  = 110 to 90VAC/60Hz, LED output voltage = 30V, and output current = 200mA. The user can follow this procedure to design applications with wider AC voltage input and DC output voltage as well.

#### **Start-up Resistor**

Start-up resistor should be chosen not to exceed the maximum start-up current. Otherwise, the RT8458A may latch low and will never start. Start-up current = 130V/R1 for 110VAC regions, 260V/R1 for 220VAC regions. The typical start-up current is  $250\mu A$ .

#### Input Diode Bridge Rectifier Selection

The current rating of the input bridge rectifier is dependent on the  $V_{OUT}/V_{IN}$  transformation ratio. The voltage rating of the input bridge rectifier,  $V_{BR}$ , on the other hand, is only dependent on the input voltage. Thus, the  $V_{BR}$  rating is calculated as below :

$$V_{BR} = 1.2 \times (\sqrt{2} \times V_{AC(MAX)})$$

where  $V_{AC,Max}$  is the maximum input voltage (RMS) and the parameter 1.2 is used for safety margin.

For this example:

$$V_{BR} = 1.2 \times (\sqrt{2} \times V_{AC(MAX)}) = (1.2 \times \sqrt{2} \times 110) = 187V$$

If the input source is universal,  $V_{BR}$  will reach 448V. In this case, a 600V, 0.5A bridge rectifier can be chosen.

#### **Input Capacitor Selection**

The input capacitor supplies the peak current to the inductor and flattens the current ripple on the input. The low ESR condition is required to avoid increasing power loss. The ceramic capacitor is recommended due to its excellent high frequency characteristic and low ESR. For maximum stability over the entire operating temperature range, capacitors with better dielectric are suggested. The minimum capacitor is given by:

$$C_{\text{IN}} \geq \frac{V_{\text{OUT}(\text{MAX})} \times I_{\text{OUT}(\text{MAX})}}{\left[\left(\sqrt{2} \times V_{\text{AC}(\text{MIN})}\right)^2 - V^2_{\text{DC}(\text{MIN})}\right] \times \eta \times f_{\text{AC}}}$$

where  $f_{\text{AC}}$  is the AC input source frequency and  $\eta$  is the efficiency of the whole system.

Notice that  $V_{DC(MIN)}$  is the minimum voltage at bridge rectifier, output and  $V_{DC(MIN)}$  should be larger than 2 x  $V_{OUT(MAX)}$ .

For a 90 to  $264V_{AC}$  universal input range, the  $V_{DC(MIN)}$  is 90V, therefore the LED string voltage  $V_{OUT(MAX)}$  should be less than 45V.



For this particular example:

$$C_{IN} \ge \frac{30 \times 0.2}{\left[ (\sqrt{2} \times 90)^2 - 90^2 \right] \times 0.9 \times 60} = 13.7 \mu F$$

In addition, the voltage rating of the input filter capacitor,  $V_{\text{CIN}}$ , should be large enough to handle the input voltage.

$$V_{CIN} \ge (1.2 \times \sqrt{2} \times V_{AC(MAX)}) = (1.2 \times \sqrt{2} \times 110) = 187V$$

Thus, a  $22\mu F / 250V$  electrolytic capacitor can be chosen in this case. Due to its large ESR, the electrolytic capacitor is not suggested for high current ripple applications.

#### **Inductor Selection**

The inductor value and operating frequency determine the ripple current according to a specific input and output voltage. The ripple current,  $\Delta I_L,$  increases with higher  $V_{IN}$  and decreases with higher inductance, as shown in equation below :

$$\Delta I_{L} = \left[ \frac{V_{OUT}}{f \times L} \right] \times \left[ 1 - \frac{V_{OUT}}{V_{IN}} \right]$$

To optimize the ripple current, the RT8458A operates the Buck converter in BCM (Boundary-Condition Mode). The largest ripple current will occur at the highest  $V_{\text{IN}}$ . To guarantee that the ripple current stays below the specified value, the inductor value should be chosen according to the following equation :

$$L = \frac{V_{OUT} \times T_{S} \times (1-D)}{2 \times I_{OUT}}$$
$$= \frac{30 \times 20.83 \mu s \times (1-0.333)}{2 \times 0.2} = 1.04 \text{mH}$$

where D is the duty cycle and T<sub>S</sub> is the switching period.

#### **Forward Diode Selection**

When the power switch turns off, the path for the current is through the diode connected between the switch output and ground. This forward biased diode must have minimum voltage drop and recovery time. The reverse voltage rating of the diode should be greater than the maximum input voltage and the current rating should be greater than the maximum load current.

In reality, the peak current through the diode is more than the maximum output current. This component current rating should be greater than 1.2 times the maximum load current and the diode reverse voltage rating should be greater than 1.2 times the maximum input voltage, assuming a  $\pm$  20% output current ripple.

The peak voltage stress of diode is:

$$V_D = 1.2 \times (\sqrt{2} \times V_{AC(MAX)}) = 1.2 \times (\sqrt{2} \times 110) = 187V$$

The current rating of diode is:

$$I_D = 1.2 \times I_{OUT,PK} = 1.2 \times 1.2 \times 0.2 = 0.288A$$

If the input source is universal ( $V_{IN}$  = 90V to 264V),  $V_D$  will reach 448V. A 600V, 2A ultra-fast diode can be used in this example.

#### **MOSFET Selection**

The peak current through this MOSFET will be over the maximum output current. This component current rating should be greater than 1.2 times the maximum load current and the reverse voltage rating of the MOSFET should be greater than 1.2 times the maximum input voltage, assuming a  $\pm$  20% output current ripple.

The peak voltage rating of the MOSFET is:

$$V_{O} = 1.2 \times (\sqrt{2} \times V_{AC(MAX)}) = 1.2 \times (\sqrt{2} \times 110) = 187V$$

The current rating of MOSFET is:

$$I_{O} = 1.2 \times I_{OUT PK} = 1.2 \times 1.2 \times 0.2 = 0.288A$$

If the input source is universal ( $V_{IN}$  = 90V to 264V),  $V_{Q}$  will reach 448V. A 600V, 2A N-MOSFET can be chosen for this example.

#### **Output Capacitor Selection**

The selection of  $C_{OUT}$  is determined by the required ESR to minimize output voltage ripple. Moreover, the amount of bulk capacitance is also a key for  $C_{OUT}$  selection to ensure that the control loop is stable. Loop stability can be checked by viewing the load transient response. The output voltage ripple,  $\Delta V_{OUT}$ , is determined by :

$$\Delta V_{OUT} \le \Delta I_L \left[ ESR + \frac{1}{8f_{OSC}C_{OUT}} \right]$$

where  $f_{OSC}$  is the switching frequency and  $\Delta I_L$  is the inductor ripple current. The output voltage ripple will be the highest at the maximum input voltage since  $\Delta I_L$  increases with input voltage. Multiple capacitors placed in parallel may be needed to meet the ESR and RMS current handling requirement. Dry tantalum, special polymer,



aluminum electrolytic and ceramic capacitors are all common selections and available in surface mount packages. Tantalum capacitors have the highest capacitance density, but it is important to only use ones that pass the surge test for use in switching power supplies. Special polymer capacitors offer very low ESR value, but with the trade-off of lower capacitance density. Aluminum electrolytic capacitors have significantly higher ESR, but still can be used in cost-sensitive applications for ripple current rating and long term reliability considerations.

#### **Thermal Protection**

A thermal protection feature is included to protect the RT8458A from excessive heat damage. When the junction temperature exceeds a threshold of 150°C, the thermal protection will turn off the GATE terminal.

#### Soldering Process of Pb-free Package Plating

To meet the current RoHS requirements, pure tin is selected to provide forward and backward compatibility with both the current industry standard SnPb-based soldering processes and higher temperature Pb-free processes. In the whole Pb-free soldering processes pure tin is required with a maximum 260°C (<10s) for proper soldering on board, referring to J-STD-020 for more information.

#### **Thermal Considerations**

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

where  $T_{J(MAX)}$  is the maximum junction temperature,  $T_A$  is the ambient temperature, and  $\theta_{JA}$  is the junction to ambient thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C. The junction to ambient thermal resistance,  $\theta_{JA}$ , is layout dependent. For

TSOT-23-6 package, the thermal resistance,  $\theta_{JA}$ , is 255°C/W on a standard JEDEC 51-3 single-layer thermal test board. The maximum power dissipation at  $T_A$ = 25°C can be calculated by the following formula:

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (255^{\circ}C/W) = 0.392W$  for TSOT-23-6 package

The maximum power dissipation depends on the operating ambient temperature for fixed  $T_{J(MAX)}$  and thermal resistance,  $\theta_{JA}$ . The derating curve in Figure 1 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

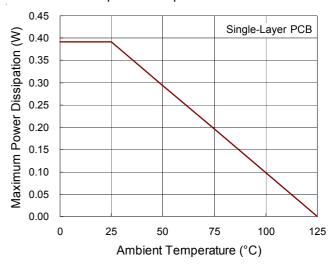


Figure 1. Derating Curve of Maximum Power Dissipation

#### **Layout Considerations**

For best performance of the RT8458A, the following layout guidelines should be strictly followed.

- ▶ The hold up capacitor, C<sub>VCC</sub>, must be placed as close as possible to the VCC pin.
- The output capacitor, C<sub>OUT</sub>, must be placed as close as possible to the LED terminal.
- ► The power GND should be connected to a strong ground plane.
- ▶ R<sub>S</sub> should be connected between the GND pin and SENSE pin.
- ▶ Keep the main current traces as short and wide as possible.
- ▶ Place L1, Q1, R<sub>S</sub>, and D1 as close to each other as possible.

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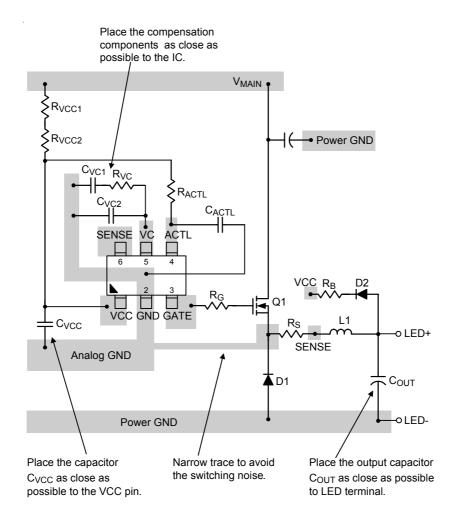
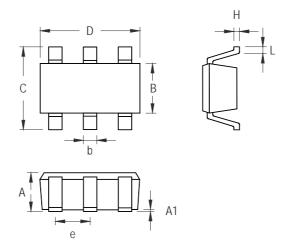


Figure 2. PCB Layout Guide



## **Outline Dimension**



O. makal	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	0.700	1.000	0.028	0.039	
A1	0.000	0.100	0.000	0.004	
В	1.397	1.803	0.055	0.071	
b	0.300	0.559	0.012	0.022	
С	2.591	3.000	0.102	0.118	
D	2.692	3.099	0.106	0.122	
е	0.838	1.041	0.033	0.041	
Н	0.080	0.254	0.003	0.010	
L	0.300	0.610	0.012	0.024	

**TSOT-23-6 Surface Mount Package** 

### **Richtek Technology Corporation**

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